



Advance Product Change Notification

201405014A

Issue Date: 18-May-2014

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to [view this notification online](#)



QUALITY

Management Summary

Introduce a second source assembly location for the remaining product types MFRC522, MFRC523, PT501 and PN512.

Change Category

<input type="checkbox"/> Wafer Fab process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Electrical spec./Test coverage	<input type="checkbox"/> Mechanical Specification
<input type="checkbox"/> Wafer Fab location	<input checked="" type="checkbox"/> Assembly Location	<input type="checkbox"/> Test Location	<input type="checkbox"/> Packing/Shipping/Labeling

Second source assembly for MFRC520, MFRC522, MFRC523, PT501 and PN512

Details of this Planned Change

Introduce MFRC5220xHN1, MFRC5230xHN1, MFRC52002HN1, PN5120A0HN1/Cx and PT5010A0HN/C1 in HVQFN32 package at ASEN, Suzhou, China as second source for current location APK (NXP Semiconductors Kaohsiung Taiwan).

Why do we Plan this Change

Capacity increase to ensure customer demand.

Identification of Affected Products

Top side marking

Packages can be identified by the assembly code that is marked on the 3rd line "C" of the product top-side marking:

APK= TSD****

ASEN= TXD****

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 07-Aug-2014

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Products will continue to be assembled in APK and will continue to ship as needed to meet customer demand.

Timing and Logistics

The Self Qualification Report will be ready on 27-Jun-2014.

The Final PCN is planned to be issued on: 07-Jul-2014.

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 17-Jun-2014.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Jean-François Tant

Position Customer Quality Manager

e-mail address jean-francois.tant@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

A global semiconductor company with operations in more than 25 countries, NXP posted unaudited revenue of \$4.36 billion in 2012.

You have received this email because you are a designated contact or subscribed to NXP's Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

[View Notification](#)

[Subscription](#)

[Support](#)

[NXP](#) | [Privacy Policy](#) | [Terms of Use](#)

NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.